Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

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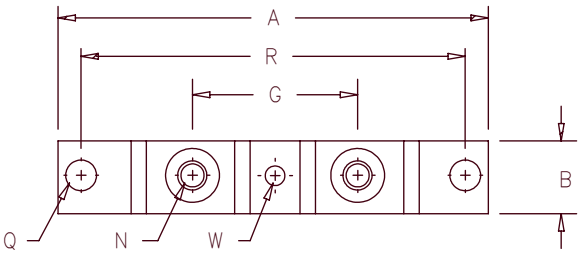
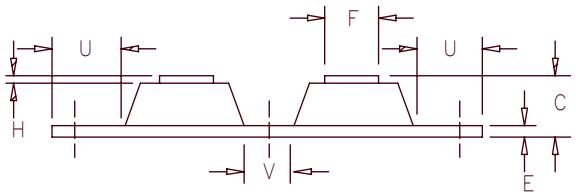
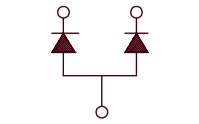
Schottky PowerMod

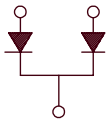
CPT60135 – CPT60145



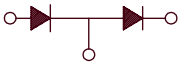




Baseplate
A=Common Anode



Baseplate
Common Cathode



Baseplate
D=Doubler

Notes:
Baseplate: Nickel plated copper

Dim.	Inches		Millimeters		
	Min.	Max.	Min.	Max.	Notes
A	---	3.630	---	92.20	
B	0.700	0.800	17.78	20.32	
C	---	0.680	---	17.28	
E	0.120	0.130	3.05	3.30	
F	0.490	0.510	12.45	12.95	
G	1.375 BSC		34.92 BSC		
H	0.010	---	0.25	---	
N	---	---	---	---	1/4–20
Q	0.275	0.290	6.99	7.37	Dia.
R	3.150 BSC		80.01 BSC		
U	0.600	---	15.24	---	
V	0.312	0.340	7.92	8.64	
W	0.180	0.195	4.57	4.95	Dia.

Microsemi Catalog Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
CPT60135*	35V	35V
CPT60140*	40V	40V
CPT60145*	45V	45V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 600 Amperes/35 to 45 Volts
- 150°C Junction Temperature
- Reverse Energy Tested
- Low Forward Voltage
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg	$I_{F(AV)}$	600 Amps	T_C = 94°C, Square wave, $R_{\theta JC}$ = 0.12°C/W
Average forward current per leg	$I_{F(AV)}$	300 Amps	T_C = 94°C, Square wave, $R_{\theta JC}$ = 0.21°C/W
Maximum surge current per leg	I_{FSM}	6000 Amps	8.3ms, half sine, T_J = 175°C
Maximum repetitive reverse current per leg	$I_{R(OV)}$	2 Amps	f = 1 KHZ, 25°C, 1µsec square wave
Max peak forward voltage per leg	V_{FM}	0.55 Volts	I_{FM} = 300A; T_J = 25°C
Max peak forward voltage per leg	V_{FM}	0.43 Volts	I_{FM} = 300A; T_J = 150°C
Max peak reverse current per leg	I_{RM}	3.0 A	V_{RRM}, T_J = 125°C*
Max peak reverse current per leg	I_{RM}	21 mA	V_{RRM}, T_J = 25°C
Typical junction capacitance per leg	C_J	15000 pF	V_R = 5.0V, T_C = 25°C

*Pulse test: Pulse width 300µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range	T_{STG}	−55°C to 150°C
Operating junction temp range	T_J	−55°C to 150°C
Max thermal resistance per leg	$R_{\theta JC}$	0.21°C/W Junction to case
Max thermal resistance per pkg	$R_{\theta JC}$	0.12°C/W Junction to case
Typical thermal resistance (greased)	$R_{\theta CS}$	0.08°C/W Case to sink
Terminal Torque		35–40 inch pounds
Mounting Base Torque (outside holes)		30–40 inch pounds
Mounting Base Torque (center hole)		8–10 inch pounds
center hole must be torqued first		
Weight		2.8 ounces (78 grams) typical

CPT60135 – CPT60145

Figure 1
Typical Forward Characteristics – Per Leg

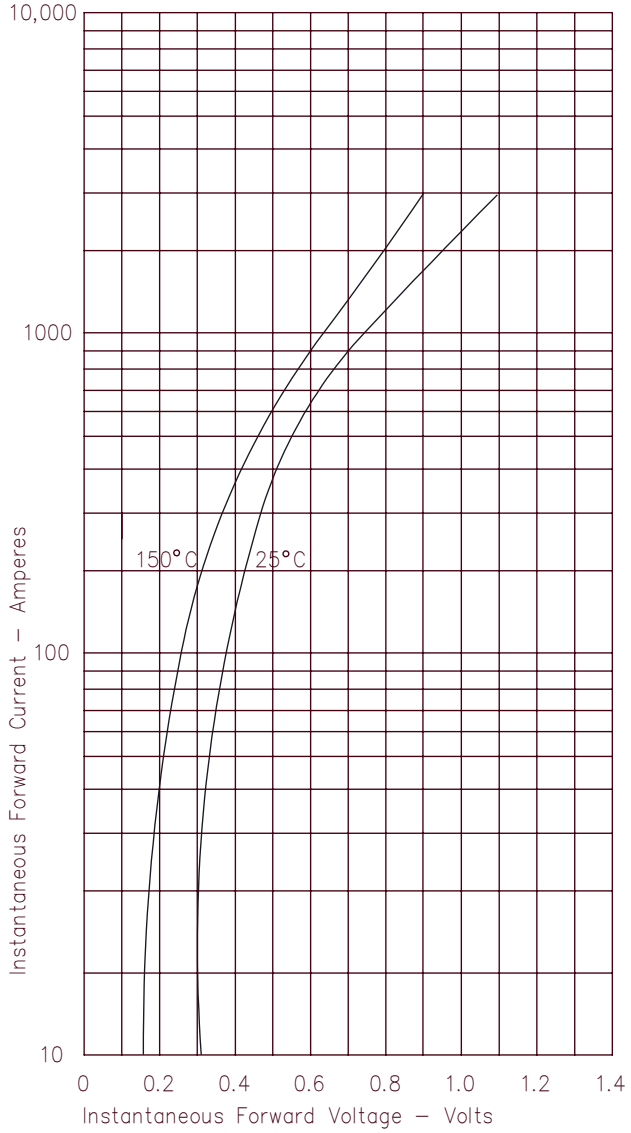


Figure 2
Typical Reverse Characteristics – Per Leg

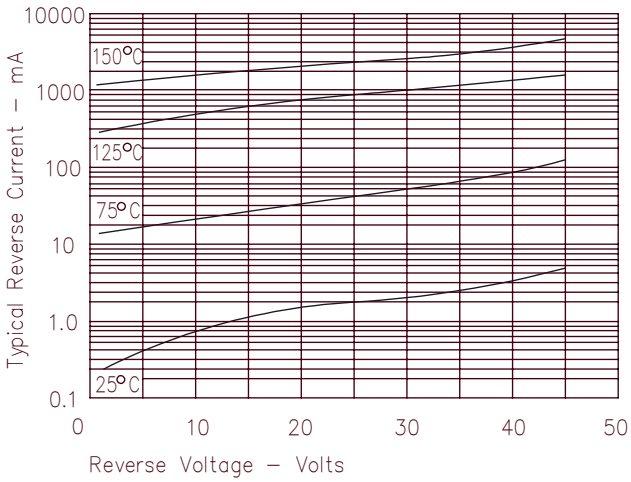


Figure 3
Typical Junction Capacitance – Per Leg

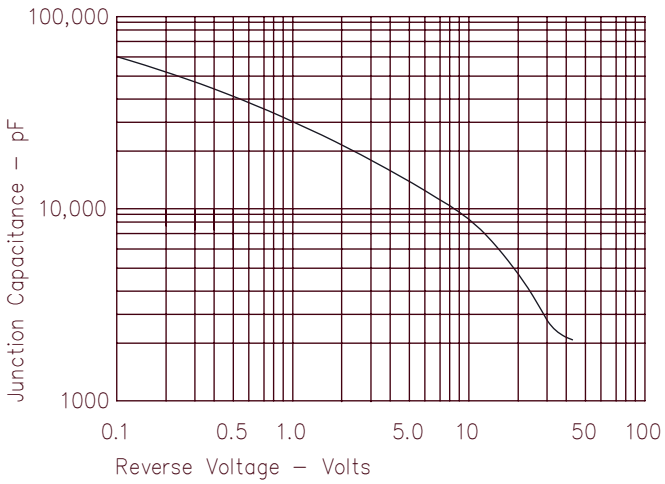


Figure 4
Forward Current Derating – Per Leg

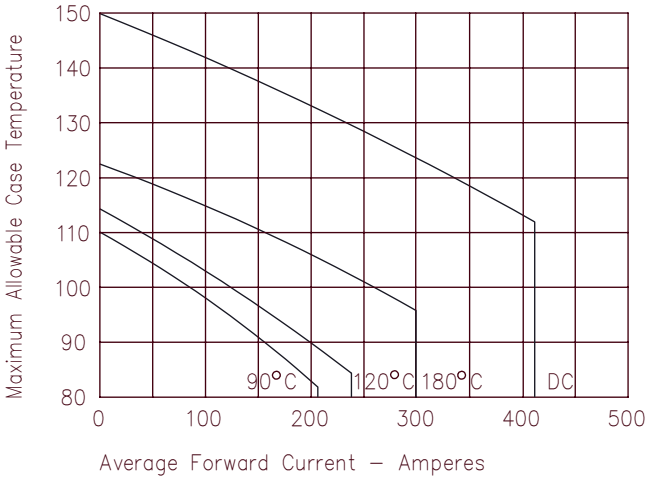
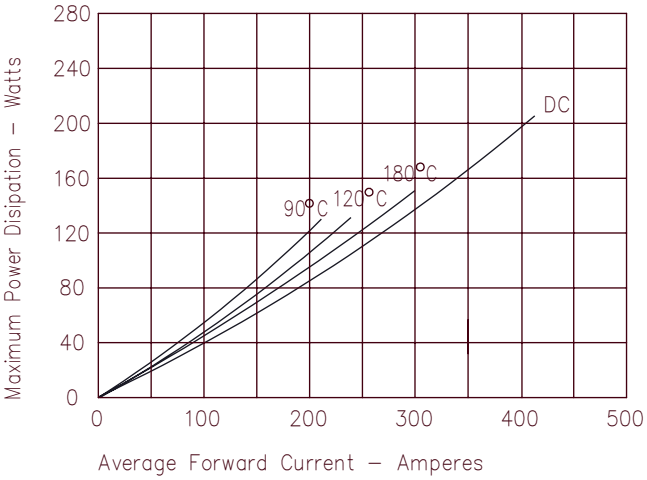


Figure 5
Maximum Forward Power Dissipation – Per Leg



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